

COMPUTATIONAL LITHOGRAPHY INFRASTRUCTURE & DEVELOPMENTS

2nd SPIE Leti litho workshop | S. BERARD | 28 February 2019



- Who are we?
- And what for ?
- Focus examples on 2019 patterning activities
- Computational Metrology 2D activities
- Towards 3D Computational Metrology
- Conclusions



COMPUTATIONAL LITHOGRAPHY GROUP – OVERVIEW



- Our missions:
 - Support Data-Preparation needs for LETI silicon technologies platform activities
 - Develop innovative computing / modeling / data treatment solutions





COMPUTATIONAL LITHOGRAPHY GROUP – ECOSYSTEM OVERVIEW





Focus examples on 2019 patterning activities

- Imagers application
- 3D Metrology
- Computational Metrology 2D activities
- Towards 3D Computational Metrology
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3D resist reflow compact model for imagers microlens shape optimization

S. Bérard-Bergery, CEA-Grenoble [10962-16]





Beyond contrast curve approach: a grayscale model applied to sub-5µm patterns P. Chevalier, STMicroelectronics S.A. - [10958-49]

Grayscale lithography process side



Grayscale lithography process study for sub 5µm microlens patterns N. Allouti, CEA-Grenoble [10958-8]





AFM

Grayscale mode

RIGOROUS SIMULATION OPTICAL _ITHOGRAPH GRAYSCALE

CONTINUOUS WORK @ LETI

- **300mm lithography** capability
- **Pursue Grayscale** technology development



Tilted beam SEM, 3D metrology for industry C. Valade, STMicroelectronics S.A. [10959-32]



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2D COMPUTATIONAL METROLOGY - WHICH NEEDS ?



COMPUTATIONAL leti **METROLOGY** COMPUTATIONAL METROLOGY – MASK SEM IMAGES Ceatech **IMAGE PROCESSING** SEM SYNTHETIC Lithography full flow expertise \rightarrow from OPC to lithography exposures... SEM CONTOURS EXTRACTION ...but advanced lithography requires great attention ! Mask images **LETI** contour ILT OPC output SEM contouring extraction solution Industrial transfer to **Algorithm solution for** mask SEM images $\bigcirc \bigcirc$ 00 \bigcirc (Robust to noise & charging effects 00 0 $\bigcirc \bigcirc$ Non CAD aware 15 mask contours

COMPUTATIONAL METROLOGY – WAFER SEM IMAGES

- Lithography full flow expertise → from OPC to lithography exposures...
- ...but advanced lithography requires great attention !

Low frame CD-SEM images



Algorithm solution for contour detection

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METROLOGY

SEM SYNTHETIC

IMAGE PROCESSING

SEM CONTOURS EXTRACTION



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TOWARDS 3D COMPUTATIONAL METROLOGY

Metrological challenges evolution



Isn't the 3D information contained in the CD-SEM images as important as the CD ?

Any other interest to have access to 3D information ?

Example: OPC resist model calibration



2 CD measured, but not at the same height.





- 3D topography reconstruction method using...
 - Azimuth tilted beam CD-SEM images from Verity tool CAPPLIED MATERIALS.
 - Stereophotogrammetry technique





3D reconstruction from geometrical considerations



Three-Dimensional (3D) Nanometrology Based on Scanning Electron Microscope (SEM) Stereophotogrammetry V. Tondare, J. Villarubia and A. Vladar (2017)



COMPUTATIONAL METROLOGY – SEM COMPACT MODEL

- Double objectives
 - > 3D topography information from electron diffusion inversion
 - Fast SEM images synthesis





JMONSEL Monte Carlo simulations for calibration





Limits of model-based CD-SEM metrology J. Bélissard et al., EIPBN 2018

COMPUTATIONAL METROLOGY



SEM images synthesis with charging effects







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Computational Lithography & Metrology expertise

Compact Models Computational Metrology Data Preparation Image Processing (optical, e-beam) (resist, SEM) (2D & 3D) Data Treatment

2019 direct topics of interest

- **Silicon Photonics**
 - > Data-preparation: OPC solutions, fracturing & mask writing
 - On-wafer results: correlation between mask & wafer level results
 - Curvilinear 2D metrics development

Imagers support: microlens definition

- > **Push Grayscale** alternative lithography technique
- Resist thermal reflow compact modeling







End Users



Close collaboration on 2D & 3D





and others ...

GLOBAL FOUNDRIES



THANK YOU FOR YOU ATTENTION





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